

Description

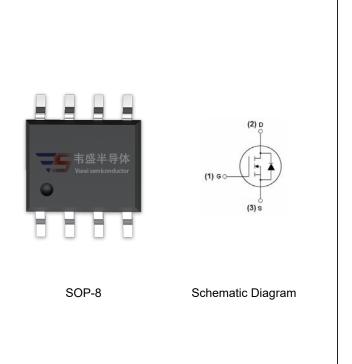
The VST08N088 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- V_{DS} =88V, I_D =14A $R_{DS(ON)}$ =8.8m Ω (typical) @ V_{GS} =10V $R_{DS(ON)}$ =9.8m Ω (typical) @ V_{GS} =4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST08N088-S8	VST08N088	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	88	V	
Gate-Source Voltage	V _G s	±20	V	
Drain Current-Continuous	I _D	14	А	
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	10	А	
Pulsed Drain Current	I _{DM}	56	А	
Maximum Power Dissipation	P _D	3.5	W	
Single pulse avalanche energy (Note 5)	E _{AS}	230	mJ	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient(Note 2)	R _{θJA}	41.7	°C/W
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Electrical Characteristics (T_A =25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	88	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =88V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.7	2.2	V
Drain-Source On-State Resistance		V _{GS} =10V, I _D =14A	-	8.8	10.2	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =10A	-	9.8	11.2	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =14A	-	30	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	\/ 40\/\/ 0\/	-	3696		PF
Output Capacitance	Coss	V_{DS} =40V, V_{GS} =0V, F=1.0MHz	-	250		PF
Reverse Transfer Capacitance	C _{rss}	r-1.0Winz	-	40		PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	11	-	nS
Turn-on Rise Time	t _r	V_{DD} =40 V , I_{D} =14 A	-	7	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =1.6 Ω	-	30	-	nS
Turn-Off Fall Time	t _f		-	4	-	nS
Total Gate Charge	Qg	\/ -40\/ -444	-	54	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=40V,I_{D}=14A,$	-	13	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	7	-	nC
Drain-Source Diode Characteristics	- '		•			
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =14A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	14	Α
Reverse Recovery Time	t _{rr}	$T_J = 25$ °C, $I_F = I_S$	-	78	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	149	-	nC

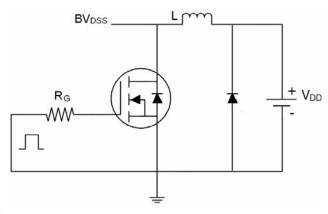
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

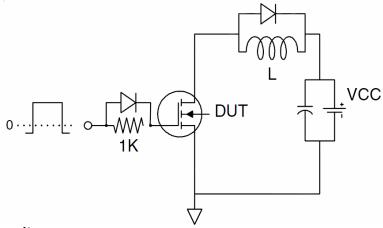


Test Circuit

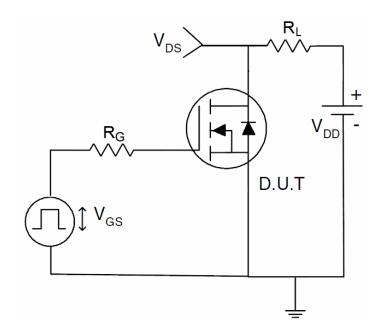
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit







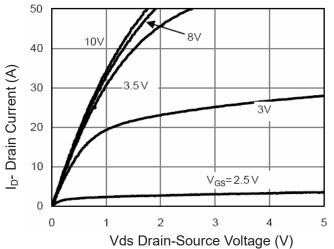


Figure 1 Output Characteristics

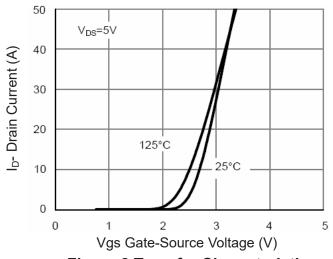
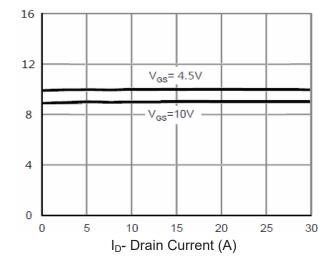


Figure 2 Transfer Characteristics



Rdson On-Resistance(m 2)

Figure 3 Rdson-Drain Current

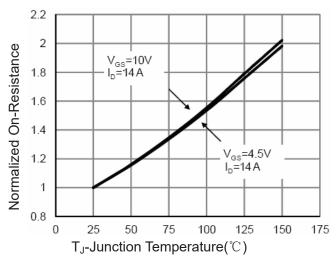


Figure 4 Rdson-Junction Temperature

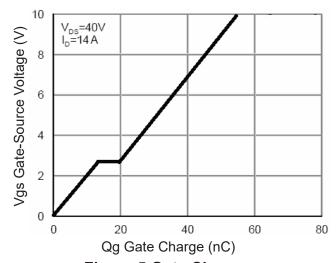


Figure 5 Gate Charge

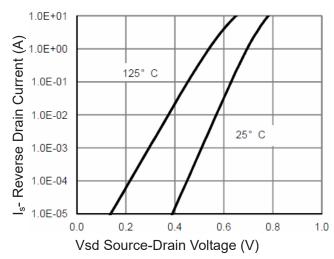
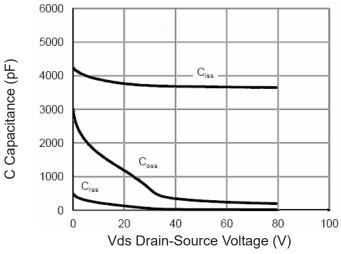


Figure 6 Source- Drain Diode Forward



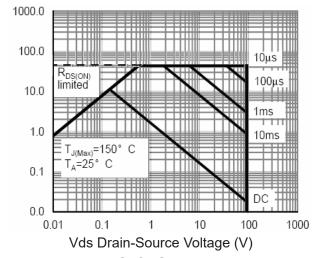
lp- Drain Current (A)



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Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



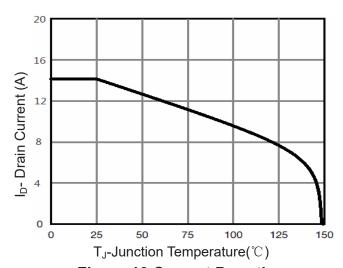
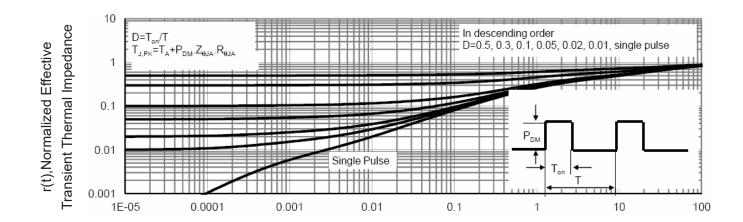


Figure 8 Safe Operation Area

Figure 10 Current De-rating



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance